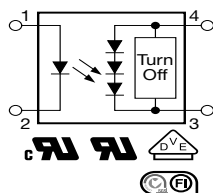
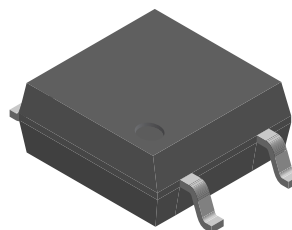


Photovoltaic MOSFET Driver With Fast Turn-Off and Enhanced Insulation Capacity



FEATURES

- Open circuit voltage at $I_F = 10$ mA, 7.7 V typical
- Short circuit current at $I_F = 10$ mA, 21 μ A typical
- Isolation test voltage 3750 V_{RMS}
- Logic compatible input
- CTI 600
- Integrated rapid turn-off circuitry
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

The VOM1272 is a stand-alone optically isolated MOSFET driver, now packaged in a mold compound with a comparative tracking index (CTI) of 600, enhancing insulation performance. The VOM1272 obtains all the required current to drive its internal circuitry from the LED current on the low voltage primary side of the isolation barrier. This saves the designer the space and cost associated with providing one or more external power supplies. The VOM1272 also integrates a turn-off circuit internal to the component itself, thus doing away with the need for additional components in order to increase the overall switching speed by decreasing the turn-off time. These features, combined with a small SOP-4 package, provide designers with a small footprint, highly integrated isolated gate driver solution for a large variety of MOSFET driver applications.

APPLICATIONS

- High-side driver
- Solid-state relays
- Floating power supply
- Power control
- Data acquisition
- ATE
- Isolated solenoid drivers
- Isolated high current relay drivers
- Isolated high voltage relay drivers

AGENCY APPROVALS

- UL (pending)
- cUL (pending)
- VDE (pending)
- FIMKO (pending)

ORDERING INFORMATION

V O M 1 2 7 2 T PART NUMBER TAPE AND REEL SOP-4 							
PACKAGE				UL, cUL, FIMKO			
SOP-4				VOM1272T			

Note

- For additional information on the available options refer to option information. The product is available only on tape and reel

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
SSR				
LED continuous forward current		I_F	50	mA
LED reverse voltage	$I_R \leq 10\text{ }\mu\text{A}$	V_R	5	V
Ambient operating temperature range		T_{amb}	-40 to +100	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +125	$^{\circ}\text{C}$
Pin soldering temperature ⁽¹⁾	$t = 10\text{ s}$	T_{sld}	260	$^{\circ}\text{C}$

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- ⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SOP)

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
LED forward voltage	$I_F = 10\text{ mA}$	V_F	1.2	1.4	1.6	V
Open circuit voltage	$I_F = 10\text{ mA}$	V_{OC}	6.8	7.7	-	V
	$I_F = 20\text{ mA}$	V_{OC}	-	8.0	-	V
	$I_F = 30\text{ mA}$	V_{OC}	-	8.1	-	V
	$I_F = 30\text{ mA}$	V_{OC}	-	8.1	-	V
Short circuit current	$I_F = 10\text{ mA}$	I_{SC}	10	21	-	μA
	$I_F = 20\text{ mA}$	I_{SC}	-	49	-	μA
	$I_F = 30\text{ mA}$	I_{SC}	-	77	-	μA

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$C_L = 200\text{ pF}$, $I_F = 20\text{ mA}$, $P_W = 2\text{ ms}$, duty cycle = 50 %	t_{on}	-	31	-	μs
Turn-off time		t_{off}	-	180	-	μs

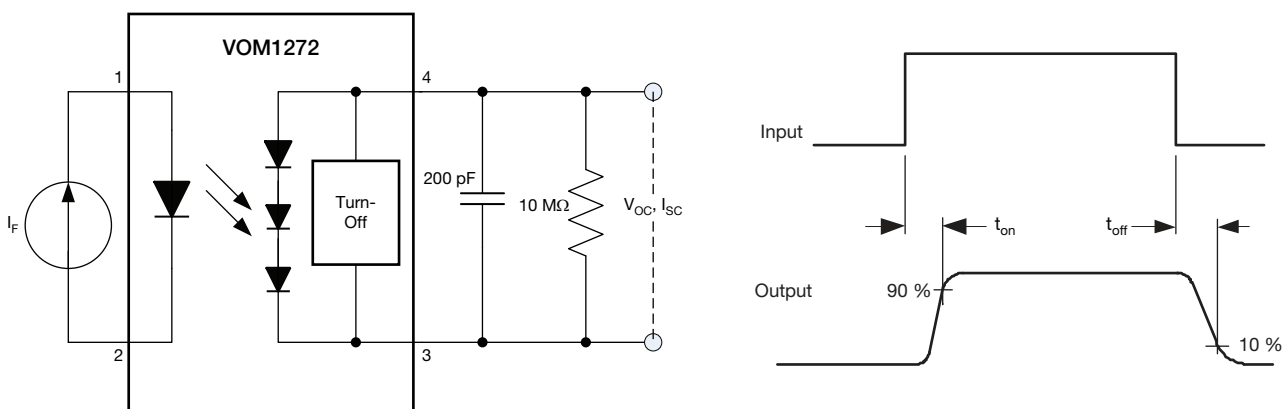


Fig. 1 - t_{on} , t_{off} Test Circuit and Waveforms

SAFETY AND INSULATION RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 110 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group I	CTI	600	
Maximum rated withstanding isolation voltage	According to UL1577, t = 1 min	V_{ISO}	3750	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	6000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	707	V_{peak}
Isolation resistance	$T_{amb} = 25^{\circ}C, V_{IO} = 500 V$	R_{IO}	$\geq 10^{12}$	Ω
	$T_{amb} = 100^{\circ}C, V_{IO} = 500 V$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	350	mW
Input safety current		I_{SI}	150	mA
Input safety temperature		T_S	175	$^{\circ}C$
Creepage distance	SOP-4		≥ 5	mm
Clearance distance	SOP-4		≥ 5	mm
Insulation thickness		DTI	≥ 0.4	mm

Note

- As per DIN EN 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

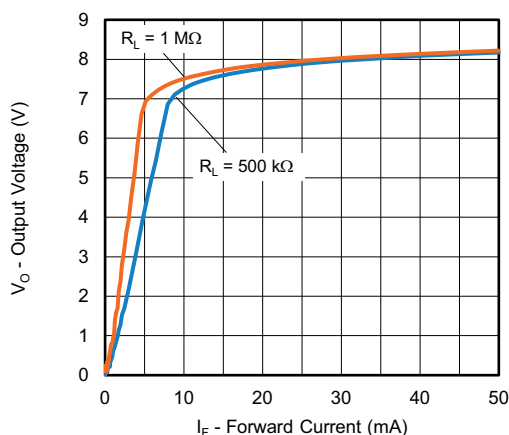
TYPICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}C$, unless otherwise specified)


Fig. 2 - Output Open Circuit Voltage vs. LED Current

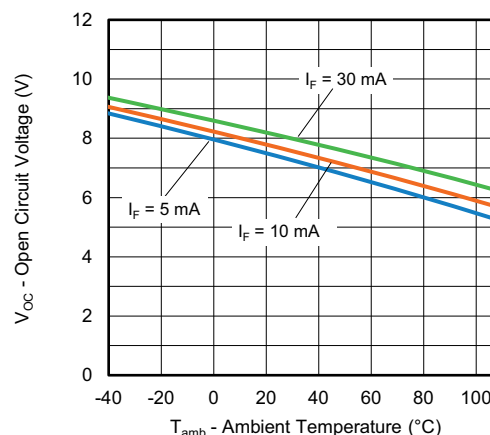


Fig. 4 - Output Open Circuit Voltage vs. Ambient Temperature

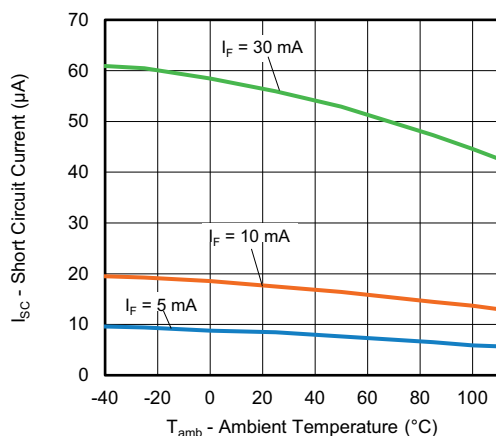
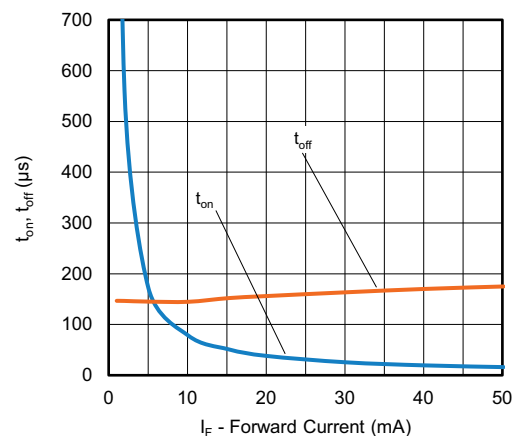


Fig. 3 - Output Short-Circuit Current vs. Ambient Temperature


Fig. 5 - t_{on} , t_{off} vs. LED Current

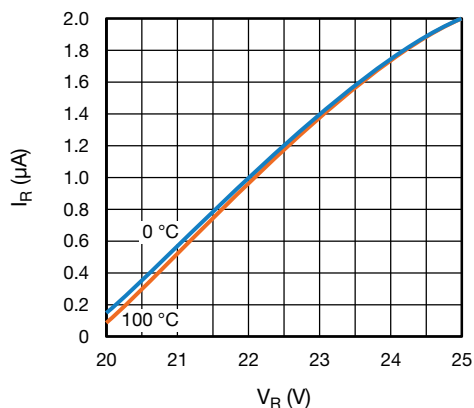


Fig. 6 - LED Reverse Current vs. Reverse Voltage

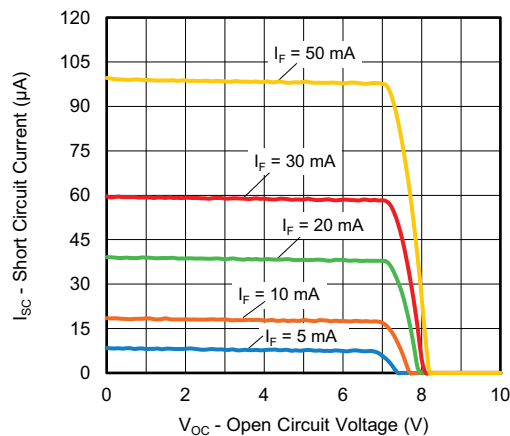


Fig. 8 - Short Circuit Output Current vs. Open Circuit Output Voltage

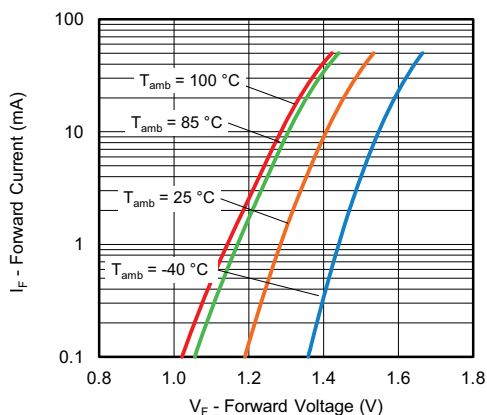


Fig. 7 - LED Forward Voltage vs. LED Forward Current

APPLICATION EXAMPLE

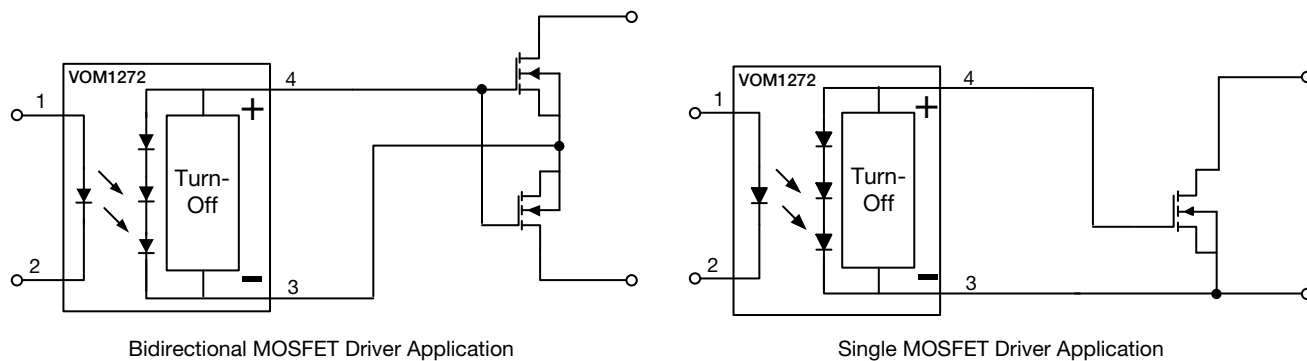
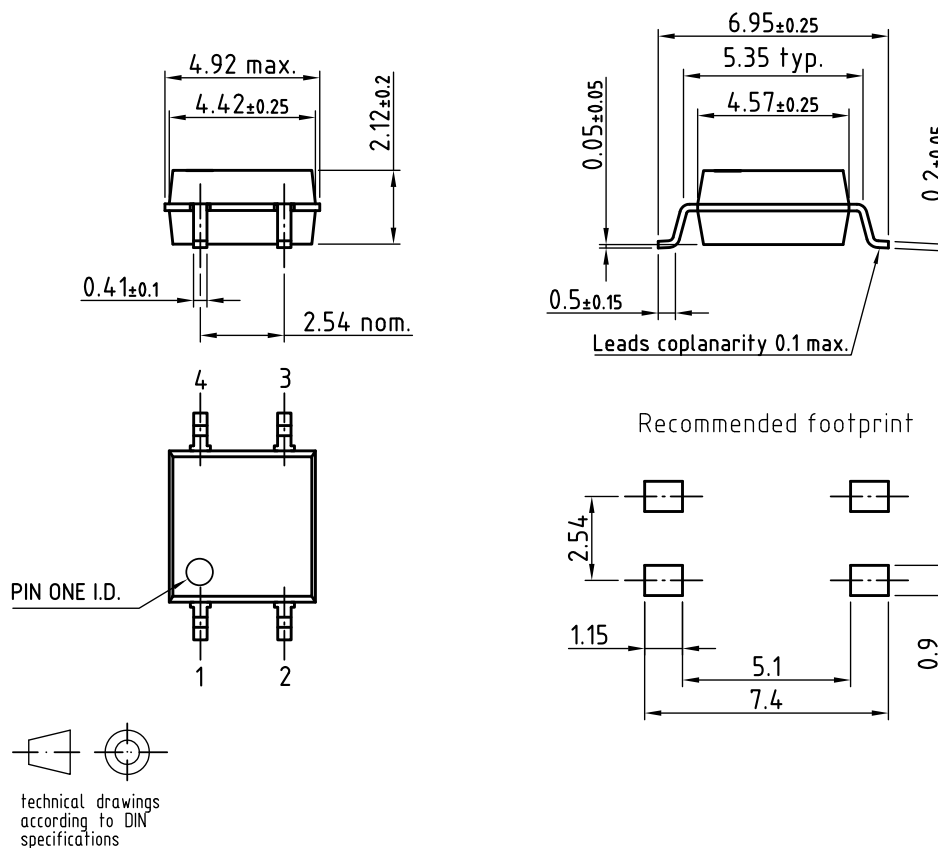
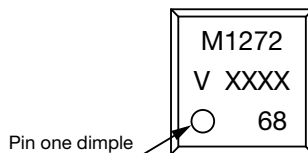


Fig. 9 - Typical MOSFET Driver Applications with Integrated Fast Turn-Off

PACKAGE DIMENSIONS in millimeters

PACKAGE MARKING (example)

Note

- XXXX = LMC (lot marking code)

TAPE AND REEL PACKAGING

Dimensions in millimeters

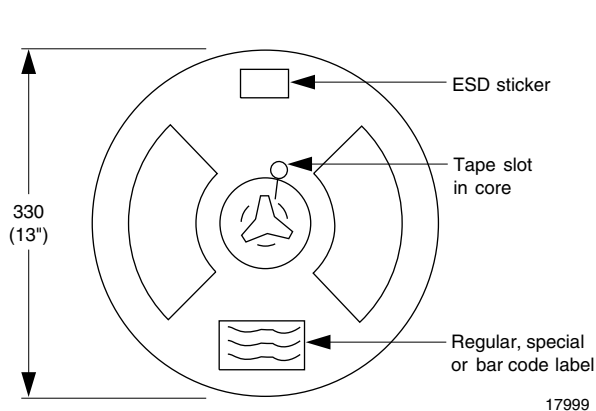


Fig. 10 - Tape and Reel Shipping Medium
(EIA-481, revision A, and IEC 60286), 2000 units per reel

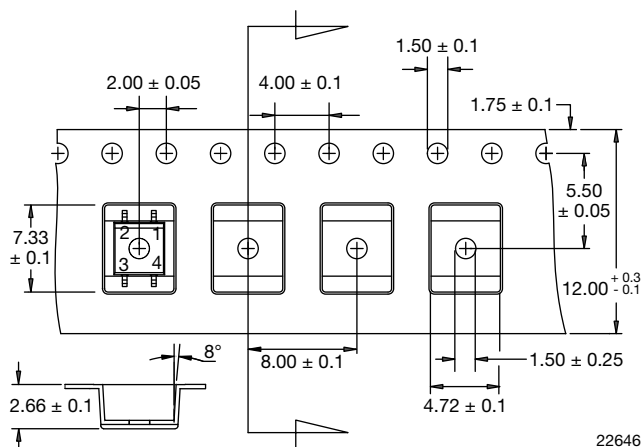


Fig. 11 - Tape Dimensions

SOLDER PROFILES

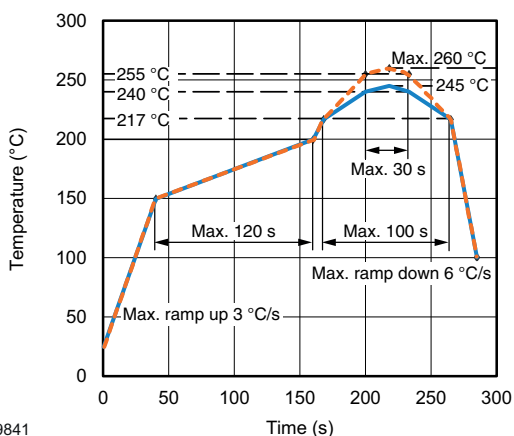


Fig. 12 - Lead (Pb)-free Reflow Solder Profile
According to J-STD-020 for SMD Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ °C}$, $RH < 60\%$

Moisture sensitivity level 1, according to J-STD-020

19841



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